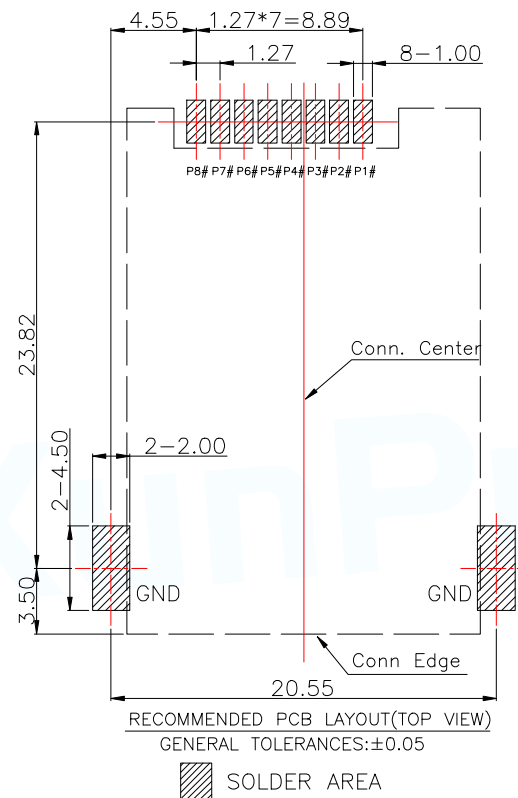
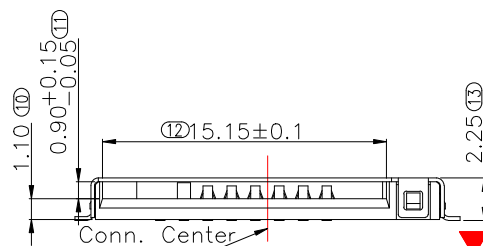
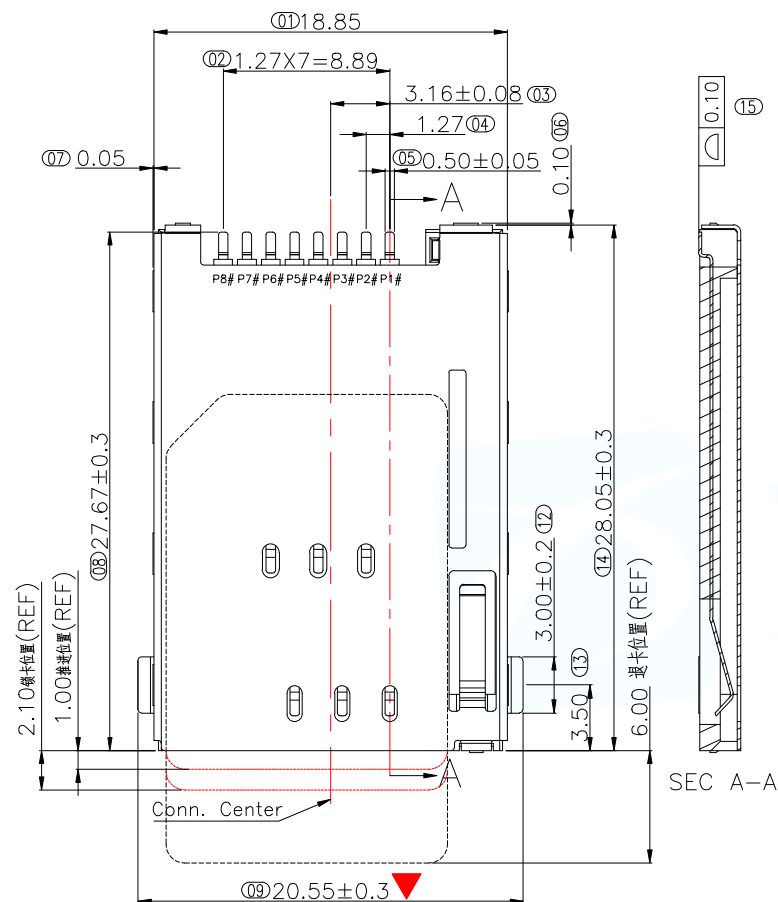
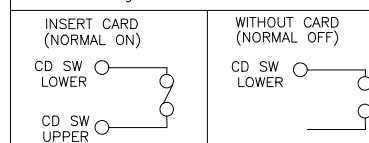




Circuit Diagram for Card Detect Switch



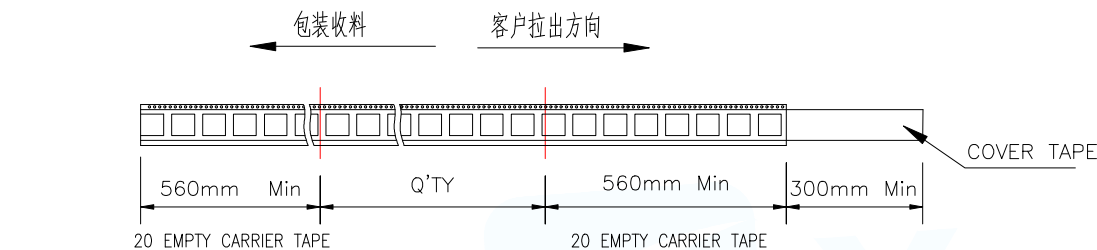
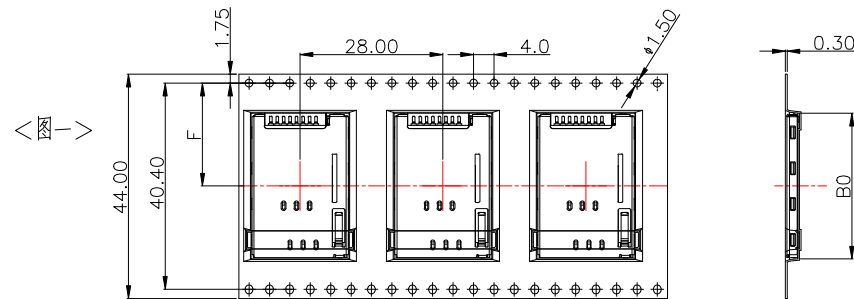
Specification

- * Electrical Characteristics :
Current Rating: 0.5A AC/DC Max.
Dielectric Withstanding Voltage: 250V AC/DC
Insulation Resistance: 500M ohms Min.
Contact Resistance: 100m ohms Max.
- * Mechanical Characteristics:
Mating Cycles: 5000 Insertions.
- * Environmental :
Operating Temperature: -40°C to +85°C.
- * Material:
1. Housing: HI-Temp plastic UL 94V-0 Rated.
2. Contact: Copper Alloy.
3. Shell: Stainless Steel SUS 304, t=0.20mm.
- * Plating :
Terminal:
Contact area: Gold Flash Plated
Over 40u" Nickel.
Solder area: 80u" Tin Plated Over
40u" Nickel.
Under plate: 40u" Min. Nickel.
Shell:
30u" Min. Nickel Plated Over All,
Solder Area: Gold Flash.

PIN NO.	DESCRIPTION
P1#	C1:VCC
P2#	C5:GND
P3#	C2:RST
P4#	C6:VPP
P5#	C3:CLK
P6#	C7:I/O
P7#	CD SW LOWER
P8#	CD SW UPPER

SIM 示意图
芯片面朝下视图

MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co., Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES		TITLE: SIM PUSH H2.2客户图	
DECIMALS:	ANGLES:	PAR	SIM-135-ARP8
.X:±0.30	X":±2°	DWN	
.XX:±0.20	X.X":±1°	CHKD	
.XXX:±0.10		APVD	
Website address		SCALE1:1	UNIT:MM
		SIZE:A4	SHEET:1F1
			REV:A



COVER TAPE PEELING
FORCE: 20gf~120gf



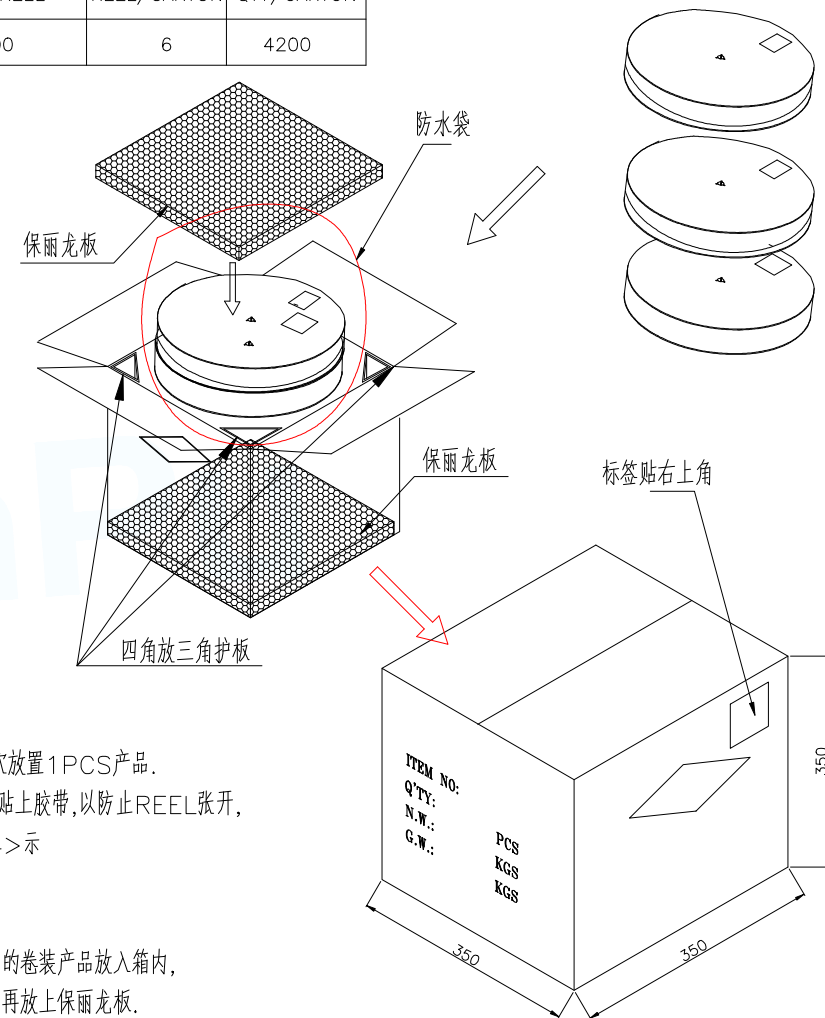
NOTE:

1. 依<图一>示放置产品于下载中, 每穴放置1PCS产品.
2. 包装机包好后, 在REEL的个等分点贴上胶带, 以防止REEL张开, 每REEL贴1PCS标签, 如<图二>示
3. 包装数量见如<TABLE 1>示
4. 包装成箱见如<图三>示
箱底放保丽龙板, 再依次将指定数量的卷装产品放入箱内, 四角分别放入四个三角护板, 最上层再放上保丽龙板.
5. 封箱, 在封好的纸箱上按客户要求写上料号, 数量等

<TABLE 1> PACKAGING QUANTITY

QTY/REEL	REEL/CARTON	QTY/CARTON
700	6	4200

<图三>



MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co., Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES		TITLE: SIM PUSH H2.2客户图	
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.XXX:±0.10		APVD	
Website address		SCALE 1:1	UNIT: MM
		SIZE: A4	SHEET: 1F1
			REV: A